

5.0X1.2X0.5 (mm) WiFi/Bluetooth Ceramic Chip Antenna

Engineering Specification

1. Product Number

YF 5010 F2 R 2G45
1 2 3 4 5



(1)Product Type	Chip Antenna
(2)Size Code	5.0x1.2x0.5mm
(3)Type Code	F2
(4)Packing	Plastic Packaging
(5)Frequency	5.8GHz



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SHEN ZHEN YINGFENG ANTENNA TECHNOLOGYCO.,LTD

Prepared by : JIEXI

Designed by : Andy

Checked by : Jason

Approved by : MR.FANG

TITLE : 5.0 x 1.2 x 0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF5010-2) Engineering Specification

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2. Features

- *Stable and reliable in performances
- *Low temperature coefficient of frequency
- *Low profile, compact size
- *RoHS compliance
- *SMT processes compatible

3. Applications

- *Bluetooth earphone systems
- *Hand-held devices when WiFi /Bluetooth functions are needed, e.g., Smart phone.
- *IEEE802.11 b/g/n
- *ZigBee
- *Wireless PCMCIA cards or USB dongle

4. Description

Yingfeng chip antenna series are specially designed for WiFi/Bluetooth applications. Based on yingfeng proprietary design and processes, this chip antenna has excellent stability and sensitivity to consistently provide high signal reception efficiency.

5. Electrical Specifications (60 x 30 mm² ground plane)

5-1. Electrical Table

Characteristics		Specifications	Unit
Outline Dimensions		5.0x1.2x0.5	mm
Working Frequency		5700~5900	MHz
VSWR		2 Max.	
Impedance		50	Ω
Polarization		Linear Polarization	
Gain	Peak	2.5 (typical)	dBi
	Efficiency	78 (typical)	%



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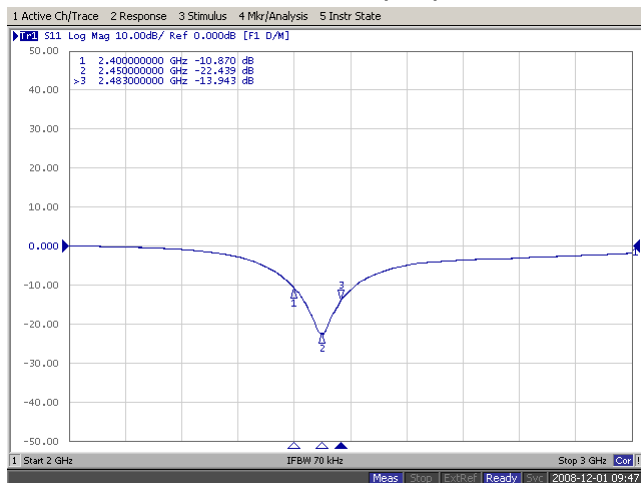
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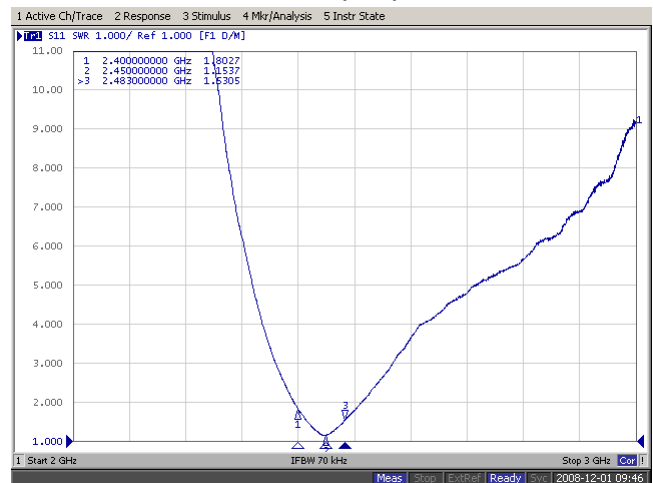
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5-2. Return Loss & VSWR

Return Loss (S₁₁)



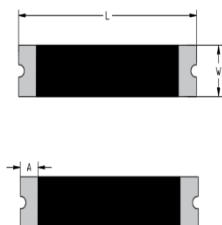
VSWR(S₁₁)



6. Antenna Dimensions & Test Board (unit: mm)

a. Antenna Dimensions

Dimension and Terminal Configuration



Dimension(mm)	
L	5.0 ±0.2
W	1.2 ±0.2
T	0.5 ±0.2
A	0.5 ±0.2

NO	Terminal Name
1	Feeding Point
2	GND



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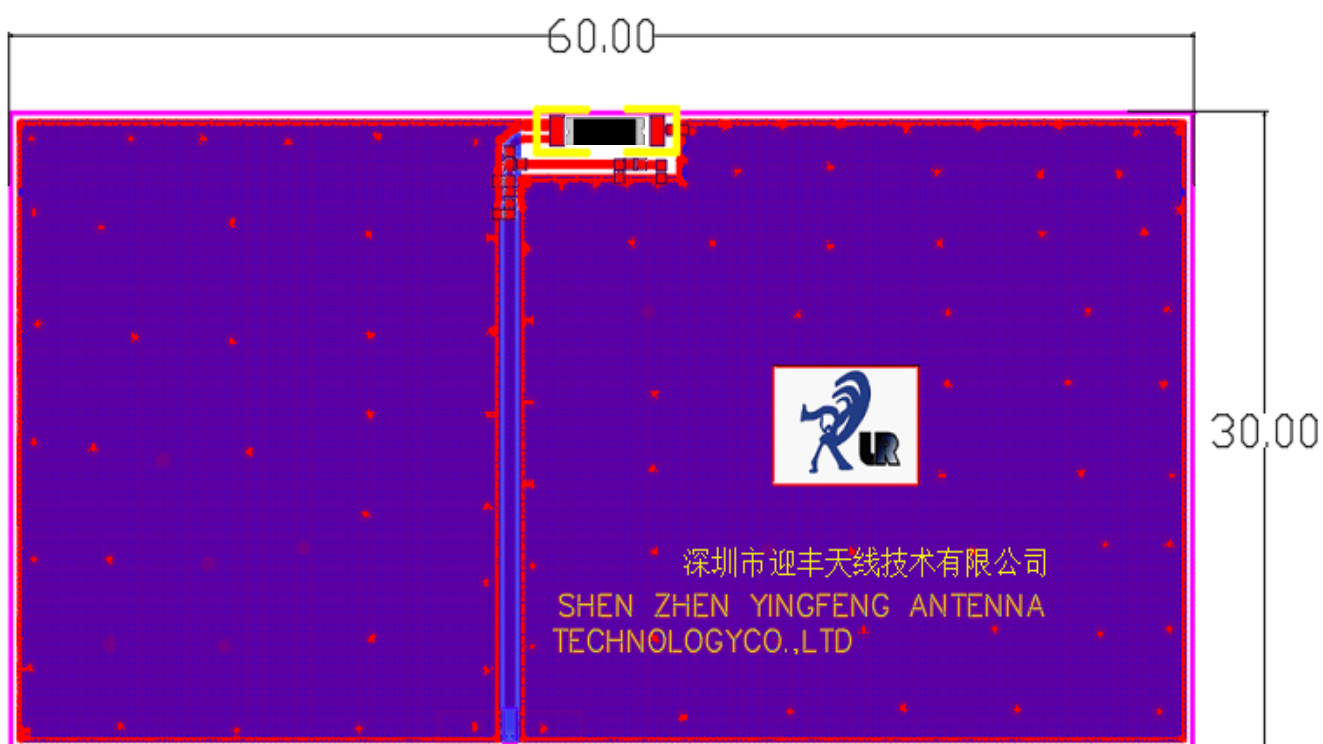
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b. Test Board with Antenna

Unit: mm



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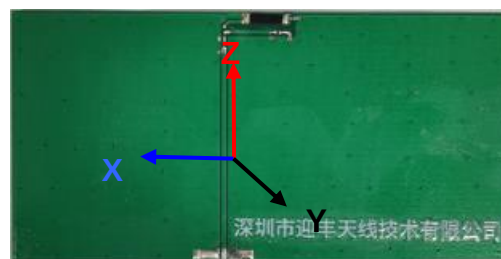
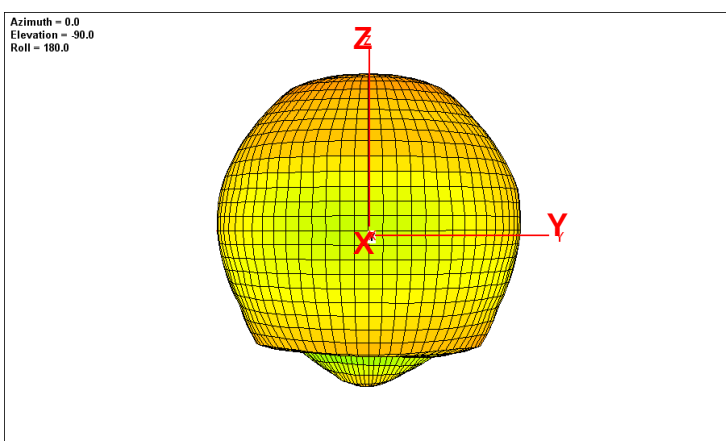
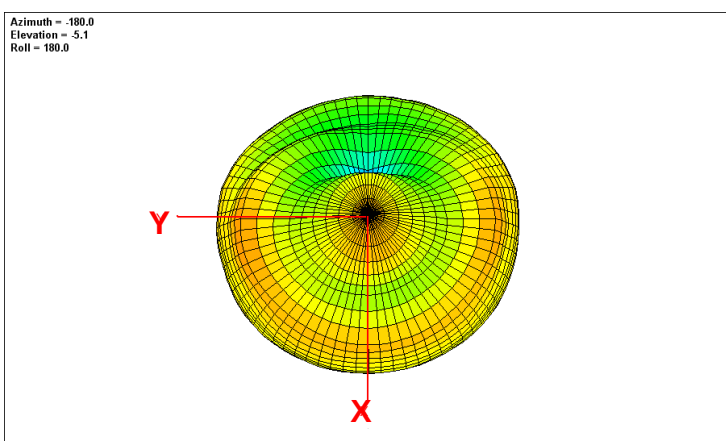
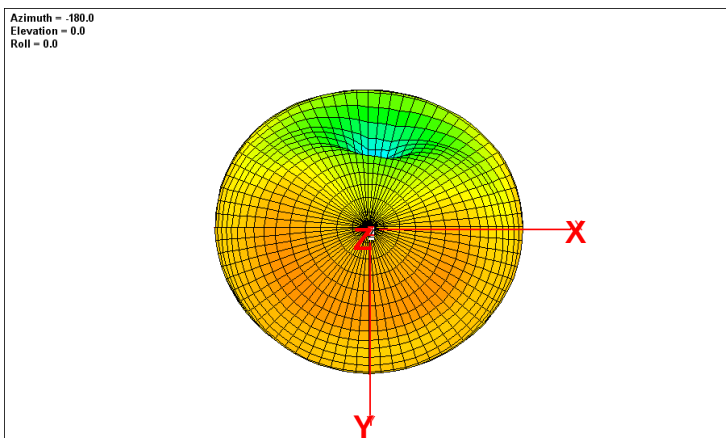
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7. Radiation Pattern (60 x 30 mm² ground plane)

7-1. 3D Gain Pattern @ 5800 MHz



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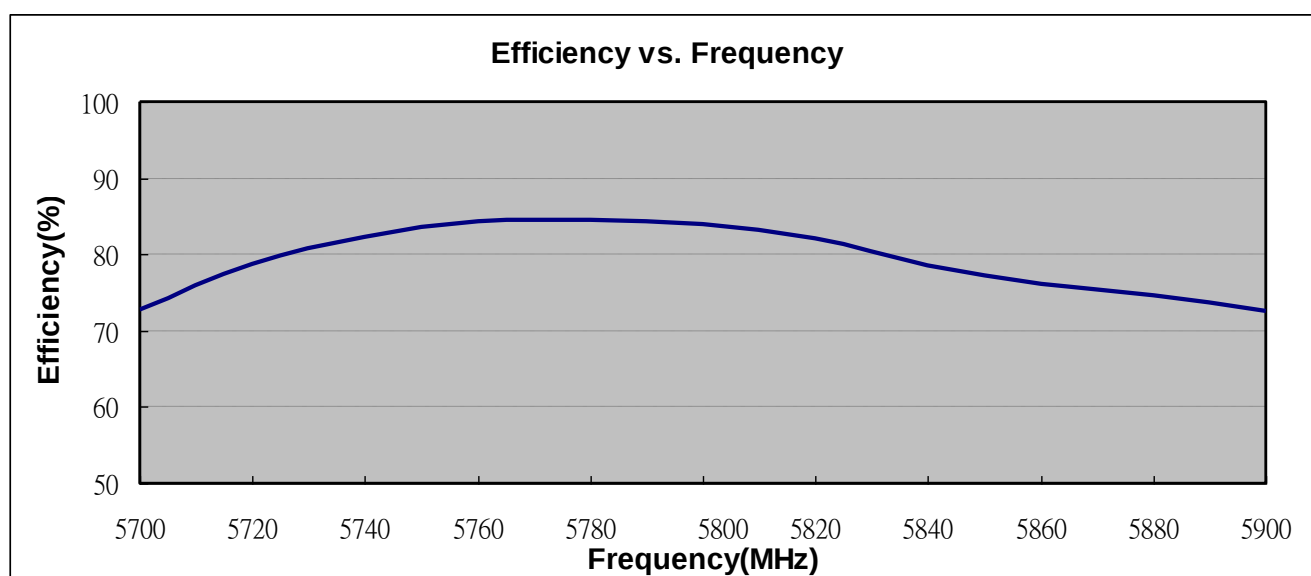
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7-2. 3D Efficiency Table

Frequency(MHz)	5700	5720	5740	5760	5780	5800	5820	5840	5860	5880	5900
Efficiency (dB)	-1.4	-1.0	-0.9	-0.7	-0.7	-0.8	-0.9	-1.1	-1.2	-1.3	-1.4
Efficiency (%)	72.8	73.7	74.3	74.4	75.5	75.0	74.0	73.6	73.1	72.6	71.5
Gain (dBi)	2.1	2.2	2.3	2.4	2.5	2.5	2.4	1.8	1.7	1.6	1.4

7-3. 3D Efficiency vs. Frequency



8. Layout Guide

a. Solder Land Pattern:

Land pattern for soldering (gray marking areas) is as shown below. Depending on Customer's requirement, matching circuit as shown below is also recommended.



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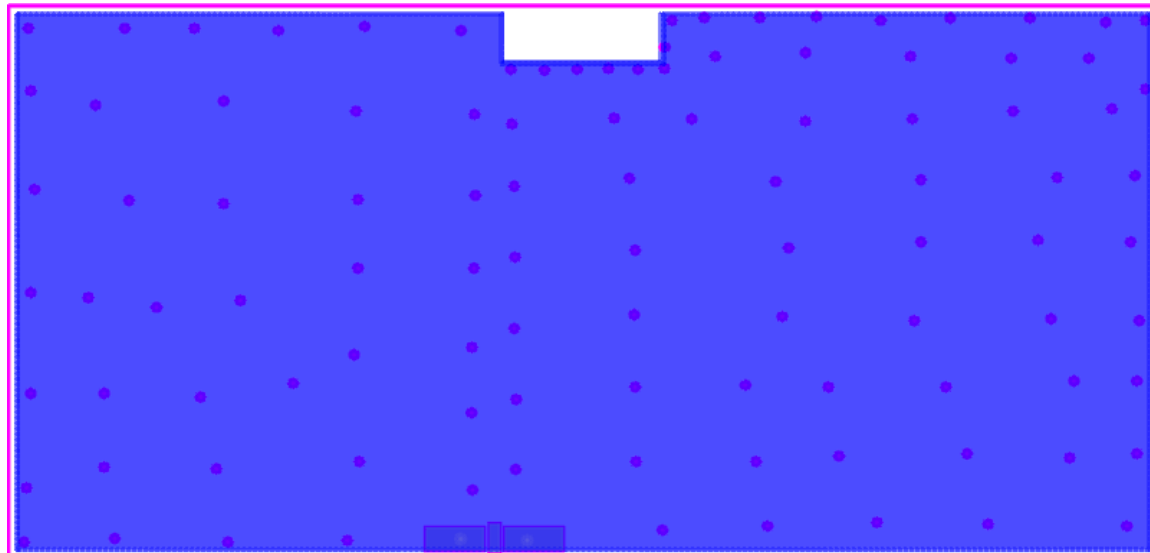
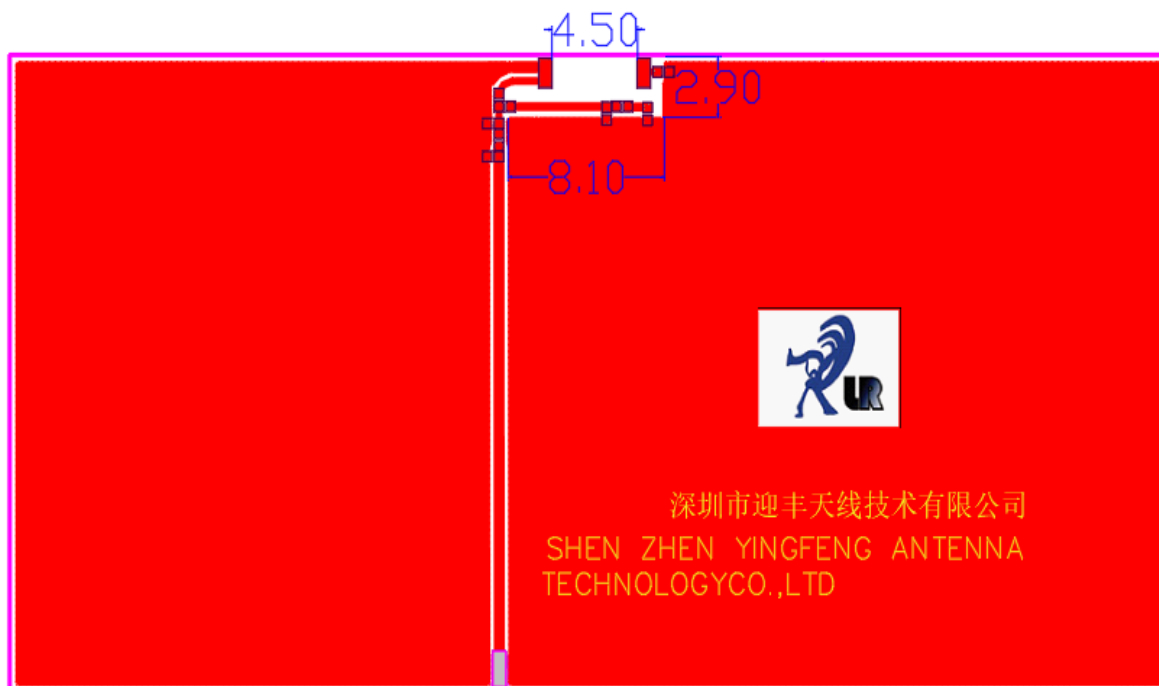
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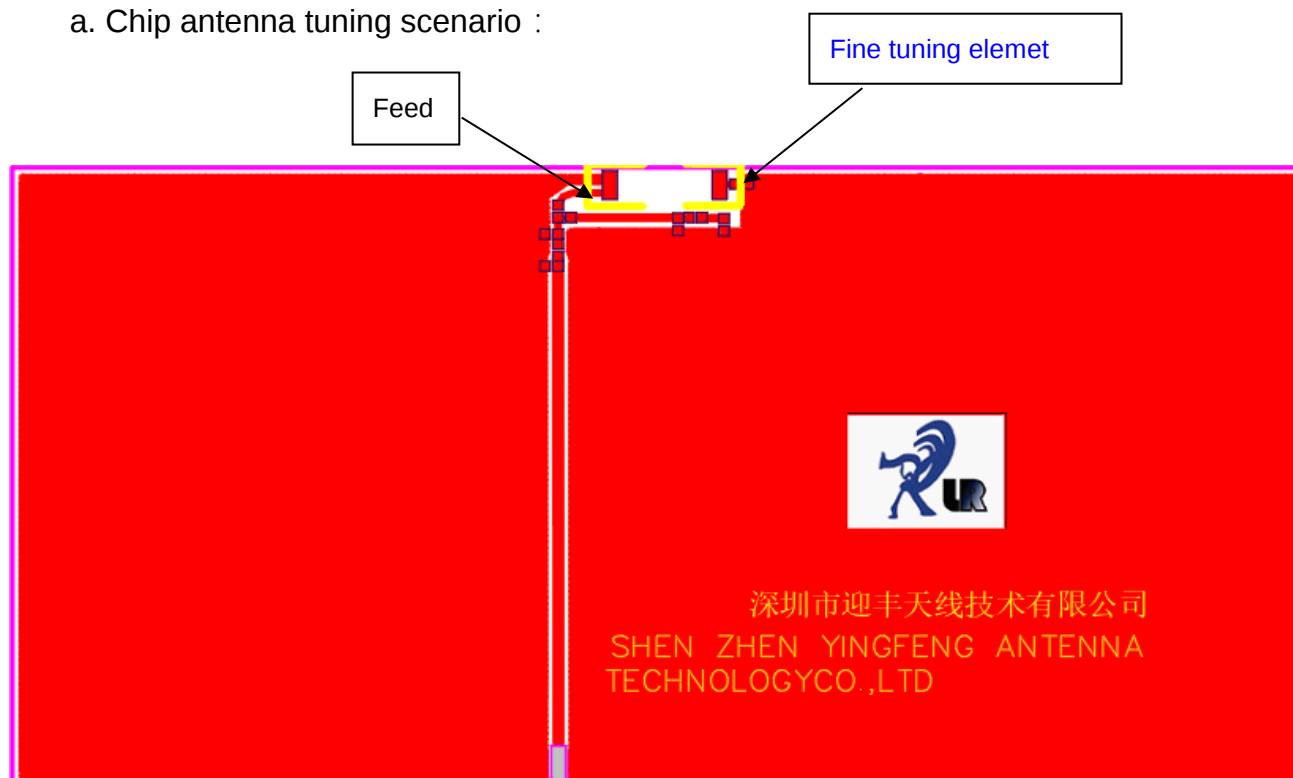
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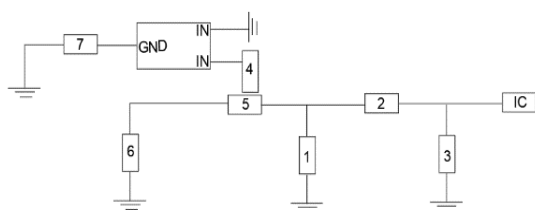
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9. Frequency tuning

a. Chip antenna tuning scenario :



b. Matching circuit : (Center frequency is about 2442 MHz @ 60 x 30 mm² ground plane)



System Matching Circuit Component			
Location	Description	Vendor	Tolerance
1	1.2 pF*	Murata (0402)	±0.1 pF
2	10PF*	Murata(0402)	±0.5 PF
3	N/A*	-	-
Fine tuning element 7	1.5 pF*	Murata (0402)	±0.1 pF

*Typical reference values which may need to be changed when circuit boards or part vendors are different.



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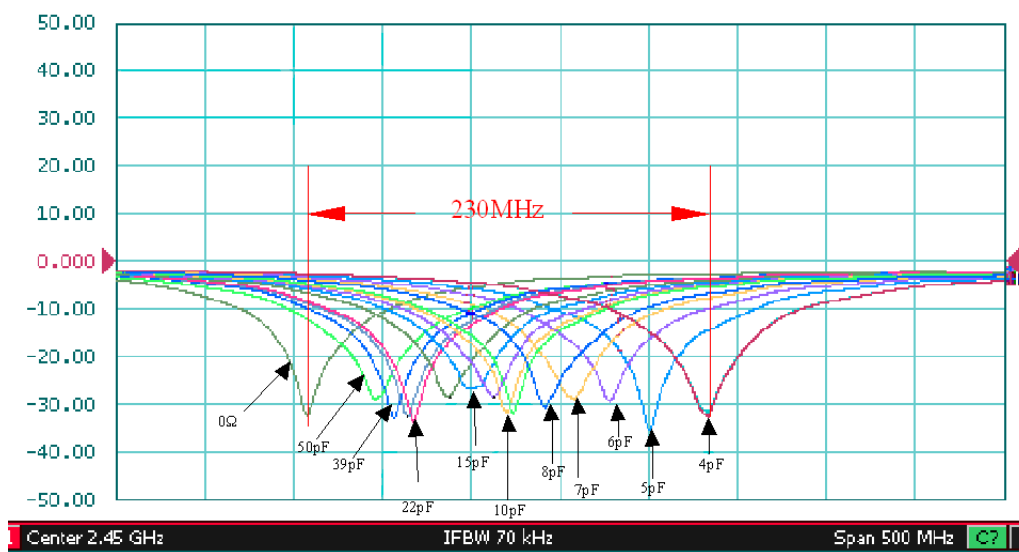
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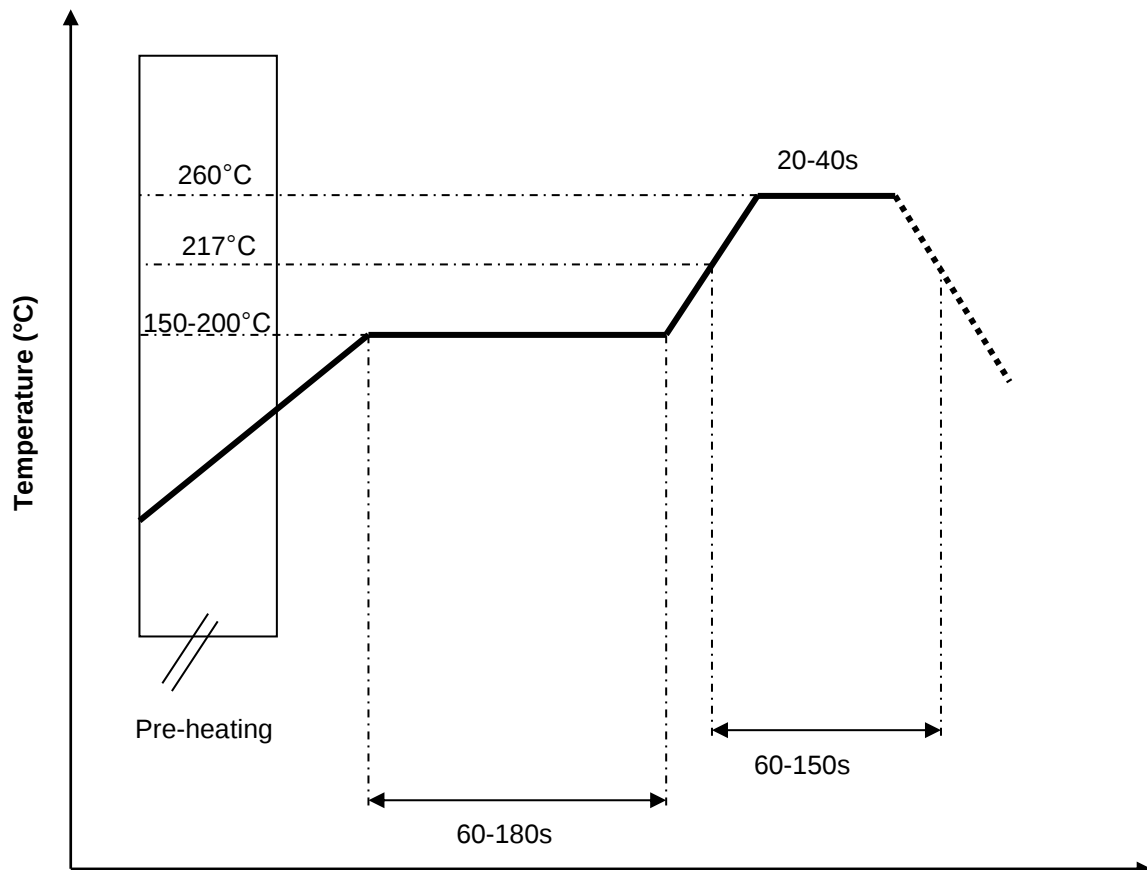
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c. Fine tuning element vs. Center frequency



10. Soldering Conditions

a. Typical Soldering Profile for Lead-free Process



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Time

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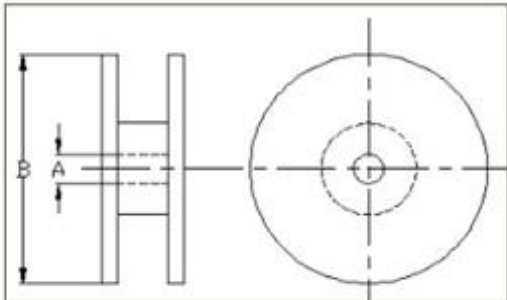
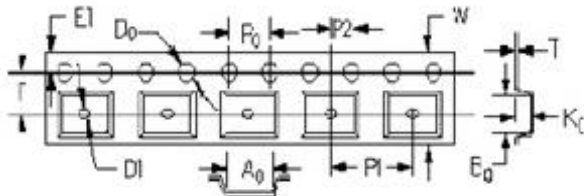
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11. Packing

(1) Quantity/Reel:5000PCS

Taping Specifications

Reel	Taping Blister Tape																																													
																																														
<table><tr><th>Checking note</th><th>Index</th><th>Spec (mm)</th></tr><tr><td>Internal diameter of reel</td><td>A</td><td>60.20 ± 0.50</td></tr><tr><td>External diameter of reel</td><td>B</td><td>178 ± 1.00</td></tr></table>	Checking note	Index	Spec (mm)	Internal diameter of reel	A	60.20 ± 0.50	External diameter of reel	B	178 ± 1.00	<table><tr><th>Checking note</th><th>Index</th><th>Spec (mm)</th></tr><tr><td>Sprocket hole</td><td>D0</td><td>1.50 +0.10/-0.00</td></tr><tr><td>Distance sprocket hole to outside</td><td>E1</td><td>1.75 ± 0.10</td></tr><tr><td>Distance sprocket hole to pocket</td><td>F</td><td>5.50 ± 0.05</td></tr><tr><td>Distance sprocket hole to sprocket hole</td><td>P0</td><td>4.00 ± 0.10</td></tr><tr><td>Distance pocket to pocket</td><td>P1</td><td>4.00 ± 0.10</td></tr><tr><td>Distance sprocket hole to pocket</td><td>P2</td><td>2.00 ± 0.05</td></tr><tr><td>Tape width</td><td>W</td><td>12.00 +0.30/-0.10</td></tr><tr><td>Pocket width nominal clearance</td><td>A0</td><td>2.28 ± 0.13</td></tr><tr><td>Pocket length nominal clearance</td><td>B0</td><td>5.70 ± 0.13</td></tr><tr><td>Pocket depth minimum clearance</td><td>K0</td><td>1.58 ± 0.10</td></tr><tr><td>Thickness of tape</td><td>T</td><td>0.23 ± 0.02</td></tr></table>	Checking note	Index	Spec (mm)	Sprocket hole	D0	1.50 +0.10/-0.00	Distance sprocket hole to outside	E1	1.75 ± 0.10	Distance sprocket hole to pocket	F	5.50 ± 0.05	Distance sprocket hole to sprocket hole	P0	4.00 ± 0.10	Distance pocket to pocket	P1	4.00 ± 0.10	Distance sprocket hole to pocket	P2	2.00 ± 0.05	Tape width	W	12.00 +0.30/-0.10	Pocket width nominal clearance	A0	2.28 ± 0.13	Pocket length nominal clearance	B0	5.70 ± 0.13	Pocket depth minimum clearance	K0	1.58 ± 0.10	Thickness of tape	T	0.23 ± 0.02
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Reliability Table

Test Item	Procedure	Requirements Ceramic Type	Remark (Reference)
Electrical Characterization		Fulfill the electrical specification	User Spec.
Thermal Shock	1. Preconditioning: 50 ± 10°C / 1 hr , then keep for 24 ± 1 hrs at room temp. 2. Initial measure: Spec: refer Initial spec. 3. Rapid change of temperature test: -30°C to +85°C; 100 cycles; 15 minutes at Lower category temperature; 15 minutes at Upper category temperature.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 107
Temperature Cycling	1. Initial measure: Spec: refer Initial spec. 2. 100 Cycles (-30°C to +85°C), Soak Mode=1 (2 Cycle/hours). 3. Measurement at 24 ± 2Hours after test condition.	No Visible Damage. Fulfill the electrical specification.	JESD22 JA104
High Temperature Exposure	1. Initial measure: Spec: refer Initial spec. 2. Unpowered; 500hours @ T=+85°C. 3. Measurement at 24 ± 2 hours after test	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
Low Temperature Storage	1. Initial measure: Spec: refer Initial spec. 2. Unpowered; 500hours @ T= -30°C. 3. Measurement at 24 ± 2 hours after test	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
Solderability (SMD Bottom Side)	Dipping method: a. Temperature: 235 ± 5°C b. Dipping time: 3 ± 0.5s	The solder should cover over 95% of the critical area of bottom side.	IEC 60384-21/22 4.10
Soldering Heat Resistance (RSH)	Preheating temperature: 150 ± 10°C. Preheating time: 1~2 min. Solder temperature: 260 ± 5°C. Dipping time: 5 ± 0.5s	No Visible Damage.	IEC 60384-21/22 4.10
Vibration	5g's for 20 min., 12 cycles each of 3 orientations Note: Use 8"X5" PCB .031" thick 7 secure points on, one long side and 2 secure points at comers of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz	No Visible Damage.	MIL-STD-202 Method 204
Mechanical Shock	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500g's Duration: 0.5ms Velocity change: 15.4 ft/s Waveform: Half-sine	No Visible Damage.	MIL-STD-202 Method 213
Humidity Bias	1. Humidity: 85% R.H., Temperature: 85 ± 2 °C. 2. Time: 500 ± 24 hours. 3. Measurement at 24 ± 2hrs after test condition.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 Method 106



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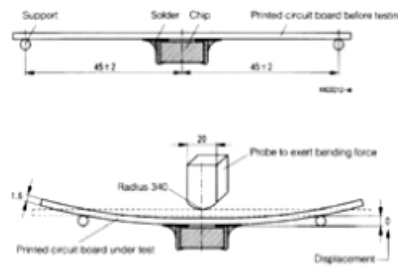
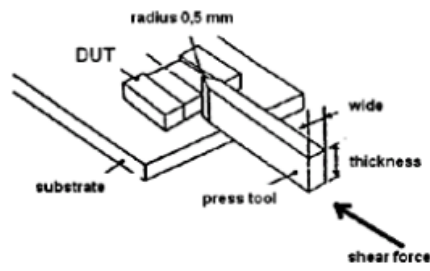
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Board Flex (SMD)	1. Mounting method: IR-Reflow. PCB Size (L:100 × W:40 × T:1.6mm) 2. Apply the load in direction of the arrow until bending reaches 2 mm. 	No Visible Damage.	AEC-Q200 005
Adhesion	Force of 1.8Kg for 60 seconds. 	No Visible Damage Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body terminals and body terminal junction.	AEC-Q200 006
Physical Dimension	Any applicable method using x10 magnification, micrometers, calipers, gauges, contour projectors, or other measuring equipment, capable of determining the actual specimen dimensions.	In accordance with specification.	JESD22 JB100



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